



MCXW236B-CLICK Board for MCX W23 Bluetooth LE MCU

MCXW236B-CLICK NEW

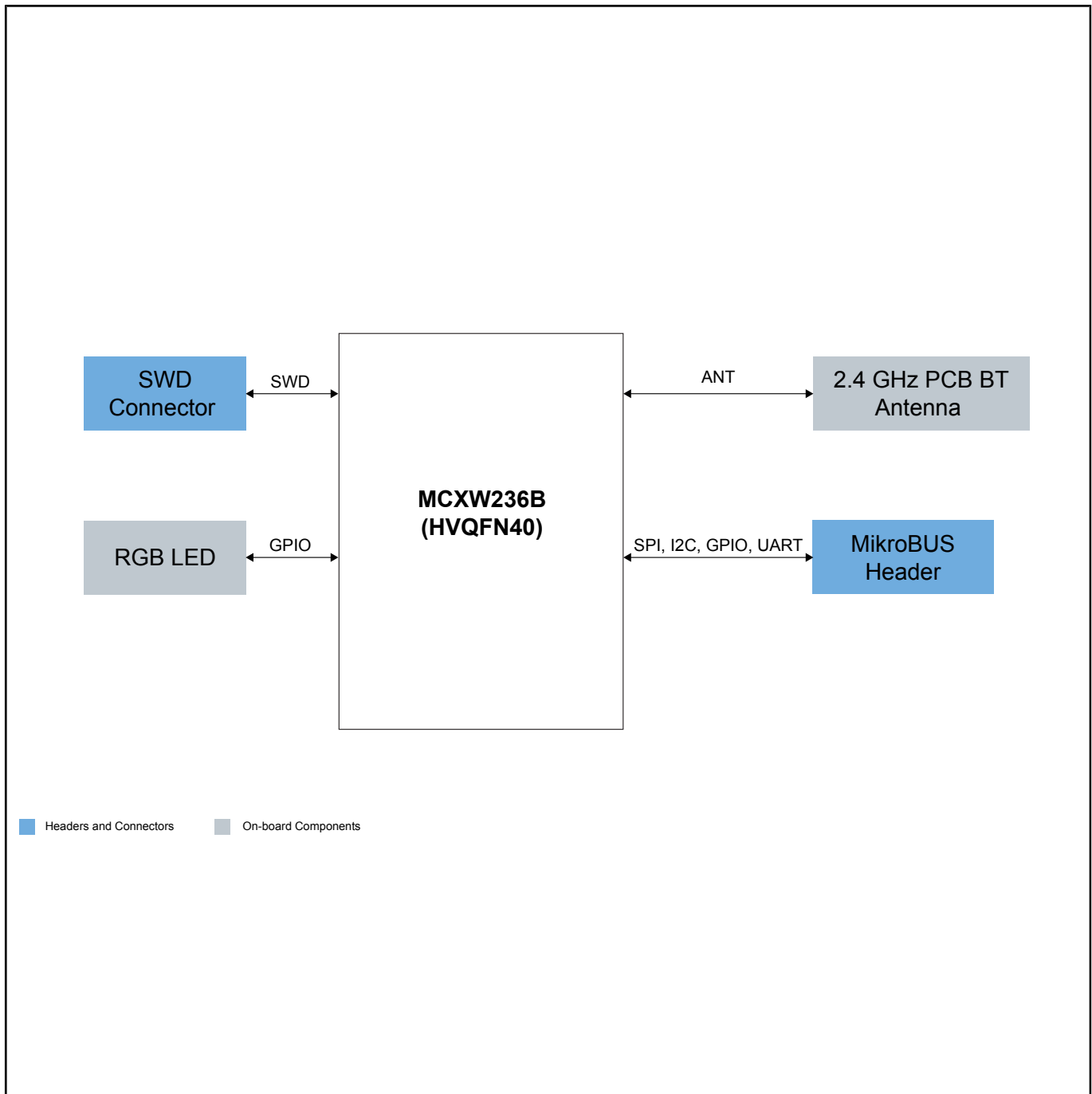
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The MCXW236B-CLICK is an add-on board that enriches NXP's expansion board hub with a Bluetooth LE Click board that enable connectivity to a wide range of MCU and MPU FRDM boards. This board features the MCX W23 Bluetooth® Low Energy (LE) 5.3 wireless microcontroller unit (MCU) and once connected to the existing FRDM boards, it offers easy evaluation and rapid prototyping of the MCX W23 wireless MCU. Connecting this board with FRDM MCXC or MCXN can also provide a medium to further explore the ADC/DAC capabilities.

MCXW236B-CLICK Block Diagram



View additional information for [MCXW236B-CLICK Board for MCX W23 Bluetooth LE MCU](#).

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